Silicon N-Channel MOS FET

HITACHI

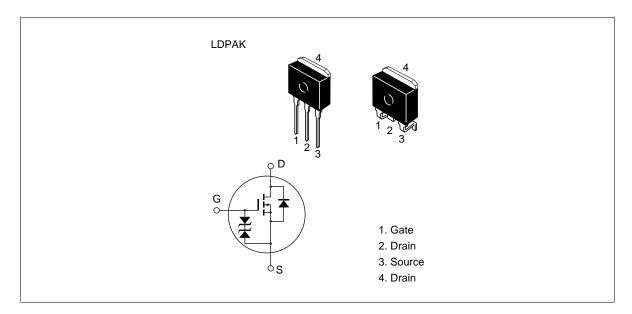
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator, DC-DC converter and motor driver

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1315	V _{DSS}	450	V
	2SK1316		500	
Gate to source voltage		V _{GSS}	±30	V
Drain current		I _D	8	А
Drain peak current		L *1 D(pulse)	32	А
Body to drain diode reverse drain current		I _{DR}	8	А
Channel dissipation		Pch*2	60	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Notes: 1. PW 10 µs, duty cycle 1%

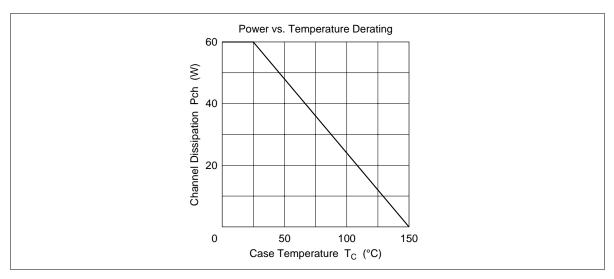
2. Value at $T_c = 25^{\circ}C$

Electrical Characteristics (Ta = 25°C)

breakdown voltage 2 Gate to source breakdovoltage Gate to source leak cur Zero gate voltage 2 drain current 2 Gate to source cutoff vo Static Drain to source 2	rrent 2SK1315	V _{(BR)DSS} V _{(BR)GSS}	450 500 ±30		—	V	$I_{\rm D}$ = 10 mA, $V_{\rm GS}$ = 0
Gate to source breakdovoltage Gate to source leak cur Zero gate voltage drain current Gate to source cutoff vo Static Drain to source 2	own rrent 2SK1315			- 			
voltageGate to source leak curZero gate voltagedrain currentZero gate to source cutoff voltageGate to source cutoff voltageStatic Drain to source 2	rrent 2SK1315		±30	_			
Zero gate voltage2drain current2Gate to source cutoff voStatic Drain to source2	2SK1315	I _{GSS}			_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
drain current 2 Gate to source cutoff vo Static Drain to source 2		200		_	±10	μA	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Gate to source cutoff vo Static Drain to source 2		I _{DSS}	_	_	250	μA	$V_{\rm DS} = 360$ V, $V_{\rm GS} = 0$
Static Drain to source	2SK1316						$V_{\rm DS} = 400 \text{ V}, V_{\rm GS} = 0$
-	oltage	$V_{GS(off)}$	2.0	—	3.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
on state resistance			_	0.55	0.7		$I_{\rm D} = 4$ A, $V_{\rm GS} = 10$ V * ¹
	2SK1316		_	0.60	0.8		
Forward transfer admitt	tance	yfs	4.5	7.5	—	S	$I_{D} = 4 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Input capacitance		Ciss	_	1150	—	pF	$V_{\text{DS}} = 10 \text{ V}, V_{\text{GS}} = 0,$
Output capacitance		Coss	_	340	—	pF	f = 1 MHz
Reverse transfer capac	citance	Crss	_	55	_	pF	
Turn-on delay time		t _{d(on)}	_	17	—	ns	$I_{D} = 4 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time		t,	_	55	_	ns	R _L = 7.5
Turn-off delay time		$t_{d(off)}$	_	100	—	ns	
Fall time		t _f	_	45	_	ns	
Body to drain diode forv voltage	ward	V_{DF}	_	0.9	_	V	$I_{F} = 8 A, V_{GS} = 0$
Body to drain diode rev recovery time	IOREO	t _{rr}	_	350	_	ns	$I_{F} = 8 A, V_{GS} = 0,$

Note: 1. Pulse test

See characteristic curves of 2SK1159, 2SK1160.



HITACHI

When using this document, keep the following in mind:

- 1. This document may, wholly or partially, be subject to change without notice.
- 2. All rights are reserved: No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without Hitachi's permission.
- 3. Hitachi will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit according to this document.
- 4. Circuitry and other examples described herein are meant merely to indicate the characteristics and performance of Hitachi's semiconductor products. Hitachi assumes no responsibility for any intellectual property claims or other problems that may result from applications based on the examples described herein.
- 5. No license is granted by implication or otherwise under any patents or other rights of any third party or Hitachi, Ltd.
- 6. MEDICAL APPLICATIONS: Hitachi's products are not authorized for use in MEDICAL APPLICATIONS without the written consent of the appropriate officer of Hitachi's sales company. Such use includes, but is not limited to, use in life support systems. Buyers of Hitachi's products are requested to notify the relevant Hitachi sales offices when planning to use the products in MEDICAL APPLICATIONS.

HITACHI

Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd. Electronic Components Div. Northern Europe Headquarters Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA United Kingdom Tel: 0628-585000 Fax: 0628-778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong Tel: 27359218 Fax: 27306071

HITACHI